

# 200mW SOD-523 SURFACE MOUNT Very Small Outline Flat Lead Plastic Package General Purpose Application Fast Switching Diode

**Absolute Maximum Ratings**  $T_A = 25$ °C unless otherwise noted

Symbol	Parameter	Value	<b>Units</b> mW	
P <sub>D</sub>	Power Dissipation	200		
T <sub>STG</sub>	Storage Temperature Range -55 to +150		°C	
TJ	Operating Junction Temperature +150		°C	
$V_{RSM}$	Non-Repetitive Peak Reverse Voltage 100		V	
V <sub>RRM</sub>	Repetitive Peak Reverse Voltage 75		V	
I <sub>FRM</sub>	Repetitive Peak Forward Current 300		mA	
Ιο	Continuous Forward Current	150	mA	
I <sub>FSM</sub>	Non-repetitive Peak Forward Surge Current (Pulse Width=1us)	2	А	

These ratings are limiting values above which the serviceability of the diode may be impaired.

## **Green Product**



SOD-523 Flat Lead



ELECTRICAL SYMBOL

#### **Specification Features:**

- Fast Switching Device (T<sub>RR</sub> <4.0 nS)
- General Purpose Diodes
- Extremely Small SOD-523 Package
- Flat Lead SOD-523 Small Outline Plastic Package
- Surface Device Type Mounting
- RoHS Compliant
- Green EMC
- Matte Tin(Sn) Lead Finish
- Band Indicates Cathode

#### **DEVICE MARKING CODE:**

Device Type	Device Marking		
1N4148WT	T4		
1N4448WT	T5		
1N914BWT	T6		

#### **Electrical Characteristics** $T_A = 25$ °C unless otherwise noted

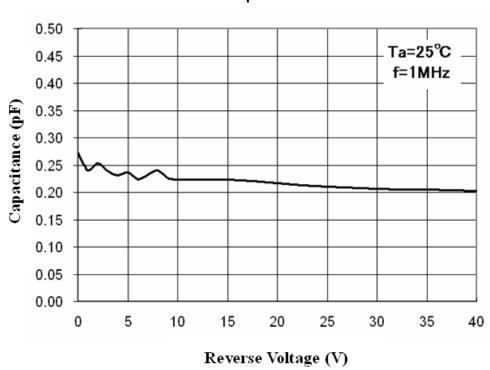
Cumahad	Parameter		Test Condition	Limits		11-4
Symbol				Min	Max	Unit
Ву	Breakdown Voltage		I <sub>R</sub> =100μA	100		Volts
			I <sub>R</sub> =5µA	75		VOILS
I <sub>R</sub>	Reverse Leakage Curr	ent	V <sub>R</sub> =20V		25	nA
			V <sub>R</sub> =75V		5	μΑ
$V_{F}$	Forward Voltage	TC1N4448WT, TC1N914BWT	I <sub>F</sub> =5mA	0.62	0.72	
		TC1N4148WT	I <sub>F</sub> =10mA		1.0	Volts
		TC1N4448WT, TC1N914BWT	I <sub>F</sub> =100mA		1.0	
$T_{RR}$	Reverse Recovery Time		I <sub>F</sub> =10mA			
			I <sub>R</sub> =60mA		4	~ C
			R <sub>L</sub> =100Ω		4	nS
			I <sub>RR</sub> =1mA			
С	Capacitance		V <sub>R</sub> =0V, f=1M <sub>HZ</sub>		4	pF

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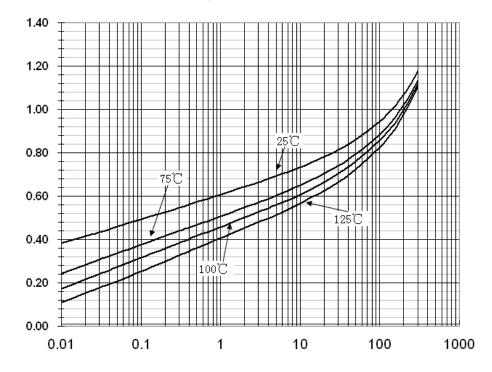


### **Typical Performance Characteristics**

### **Total Capacitance**

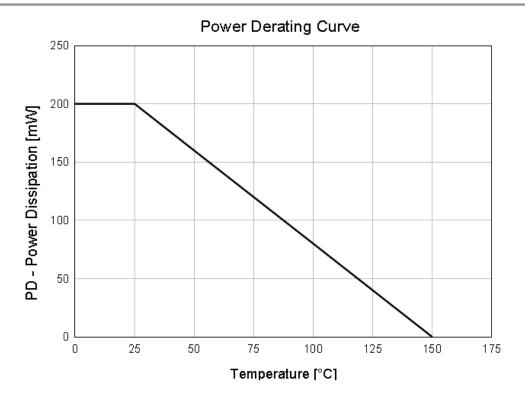


## Forward Voltage vs Ambient Temperature

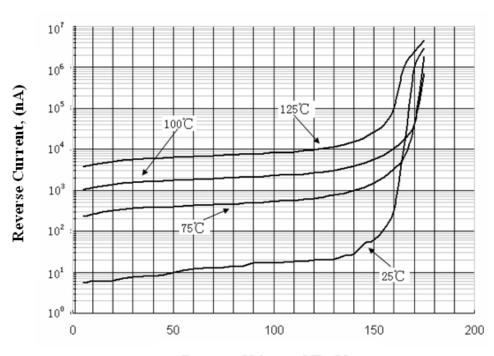


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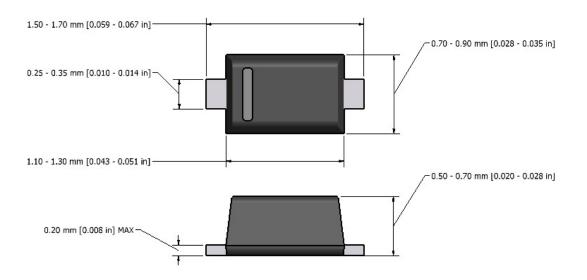
## Reverse Current vs Reverse VoltageReverse



Reverse Voltage, VR (V)



### Flat Lead SOD-523 Package Outline



Note: Dimensions are exclusive of Burrs, Mold Flash & Tie Bar extrusions.



#### NOTICE

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Number: DB-111 April 29, 2008 / A